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**NOTICE OF LISTING ON  
THE STOCK EXCHANGE OF HONG KONG LIMITED**

**JIANGSU YUEDA GROUP CO., LTD.**

**(江苏悦达集团有限公司)**

*(incorporated in the People’s Republic of China with limited liability)*

**(the “Issuer”)**

**U.S.\$100,000,000 5.70 PER CENT. BONDS DUE 2023 (THE “NEW BONDS”)  
(TO BE CONSOLIDATED AND FORM A SINGLE SERIES WITH THE U.S.\$100,000,000 5.70  
PER CENT. BONDS DUE 2023, TOGETHER WITH THE NEW BONDS, THE “BONDS”)  
(Stock Code: 40243)**



*Joint Global Coordinators*

**BOSC International**

**China International Capital Corporation**

*Joint Bookrunners and Joint Lead Managers*

**BOSC International**

**China International Capital  
Corporation**

**Industrial Bank Co., Ltd. Hong Kong  
Branch**

**TF International**

**Shanghai Pudong Development Bank Hong Kong Branch**

Application has been made to The Stock Exchange of Hong Kong Limited for the listing of and permission to deal in the New Bonds by way of debt issues to professional investors (as defined in Chapter 37 of the Rules Governing the Listing of Securities on The Stock Exchange of Hong Kong Limited and in the Securities and Futures Ordinance (Cap. 571) of Hong Kong) only as described in the Offering Circular relating thereto dated 29 September 2020. Permission for the listing of, and dealing in, the New Bonds is expected to become effective on 14 October 2020.

13 October 2020

*As at the date of this announcement, the directors of the Issuer are WANG, Lianchun (王连春), QI, Guangya (祁广亚), YANG, Yuqing (杨玉晴), XU, Zhaojun (徐兆军), LIU, Xunlong (刘训龙), XIE, Zisheng (解子胜), ZENG, Wei (曾玮), TANG, Rujun (唐如军), MAO, Daoliang (毛道良) and XU, Jinrong (徐锦荣).*